



1 nV/ $\sqrt{\text{Hz}}$, Low Power, Rail-to-Rail Output Amplifier

Known Good Die

ADA4897-2-KGD

FEATURES

Low wideband noise

1 nV/ $\sqrt{\text{Hz}}$

2.8 pA/ $\sqrt{\text{Hz}}$

Low 1/f noise: 2.4 nV/ $\sqrt{\text{Hz}}$ at 10 Hz

Low distortion: -115 dBc at 100 kHz, $V_{\text{OUT}} = 2 \text{ V p-p}$

Low input offset voltage: 500 μV maximum

High speed

-3 dB bandwidth: 230 MHz ($G = +1$)

Slew rate: 120 V/ μs

Settling time to 0.1%: 45 ns

Rail-to-rail output

Wide supply range: 3 V to 10 V

Disable feature

Known good die (KGD): these die are fully guaranteed to data sheet specifications

APPLICATIONS

Low noise preamplifiers

Ultrasound amplifiers

Phase-locked loop (PLL) filters

High performance ADC drivers

Digital-to-analog converter (DAC) buffers

GENERAL DESCRIPTION

The ADA4897-2-KGD¹ is a unity-gain stable, low noise, rail-to-rail output, high speed voltage feedback amplifier that has a quiescent current of 3 mA. With a 1/f noise of 2.4 nV/ $\sqrt{\text{Hz}}$ at 10 Hz and a spurious-free dynamic range of -80 dBc at 2 MHz, the ADA4897-2-KGD is an ideal solution in a variety of applications, including ultrasound, low noise preamplifiers, and drivers of high performance analog-to-digital converters (ADCs). The Analog Devices, Inc., proprietary next generation silicon germanium (SiGe) bipolar process and innovative architecture enable such high performance amplifiers.

The ADA4897-2-KGD has a 230 MHz bandwidth, a 120 V/ μs slew rate, and settles to 0.1% in 45 ns. With a wide supply voltage range of 3 V to 10 V, the ADA4897-2-KGD is ideal for systems that require high dynamic range, precision, low power, and high speed.

The ADA4897-2-KGD is rated to work over the industrial temperature range of -40°C to +125°C.

Additional application and technical information can be found in the [ADA4897-2](#) data sheet.

¹ Protected by U.S. Patent Numbers 6,486,737B1 and 6,518,842B1.

Rev. C

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REVISION HISTORY

2/2019—Rev. B to Rev. C		11/2014—Rev. 0 to Rev. A	
Changes to Product Title, Features Section, Applications Section, and General Description Section	1	Change to Thickness Parameter, Table 6.....	10
3/2015—Rev. A to Rev. B		4/14—Revision 0: Initial Version	
Changes to Figure 1 and Table 5.....	9		
Changes to Table 6.....	10		
Update Outline Dimensions	10		
Changes to Ordering Guide	10		

SPECIFICATIONS

±5 V SUPPLY

$T_A = 25^\circ\text{C}$, $G = +1$, $R_L = 1\text{ k}\Omega$ to ground, unless otherwise noted.

Table 1.

Parameter	Test Conditions/Comments	Min	Typ	Max	Unit
DYNAMIC PERFORMANCE					
-3 dB Bandwidth	$G = +1$, $V_{OUT} = 0.02\text{ V p-p}$		230		MHz
	$G = +1$, $V_{OUT} = 2\text{ V p-p}$		30		MHz
Bandwidth for 0.1 dB Flatness	$G = +2$, $V_{OUT} = 0.02\text{ V p-p}$		90		MHz
	$G = +2$, $V_{OUT} = 2\text{ V p-p}$, $R_L = 100\ \Omega$		7		MHz
Slew Rate	$G = +2$, $V_{OUT} = 6\text{ V step}$		120		V/ μs
Settling Time to 0.1%	$G = +2$, $V_{OUT} = 2\text{ V step}$		45		ns
Settling Time to 0.01%	$G = +2$, $V_{OUT} = 2\text{ V step}$		90		ns
NOISE/HARMONIC PERFORMANCE					
Harmonic Distortion (SFDR)	$V_{OUT} = 2\text{ V p-p}$				
	$f_C = 100\text{ kHz}$		-115		dBc
	$f_C = 1\text{ MHz}$		-93		dBc
	$f_C = 2\text{ MHz}$		-80		dBc
	$f_C = 5\text{ MHz}$		-61		dBc
Input Voltage Noise	$f = 10\text{ Hz}$		2.4		nV/ $\sqrt{\text{Hz}}$
	$f = 100\text{ kHz}$		1		nV/ $\sqrt{\text{Hz}}$
Input Current Noise	$f = 10\text{ Hz}$		11		pA/ $\sqrt{\text{Hz}}$
	$f = 100\text{ kHz}$		2.8		pA/ $\sqrt{\text{Hz}}$
0.1 Hz to 10 Hz Noise	$G = +101$, $R_F = 1\text{ k}\Omega$, $R_G = 10\ \Omega$		99		nV p-p
DC PERFORMANCE					
Input Offset Voltage		-500	-28	+500	μV
Input Offset Voltage Drift			0.2		$\mu\text{V}/^\circ\text{C}$
Input Bias Current		-17	-11	-4	μA
Input Bias Current Drift			3		nA/ $^\circ\text{C}$
Input Bias Offset Current		-0.6	-0.02	+0.6	μA
Open-Loop Gain	$V_{OUT} = -4\text{ V to }+4\text{ V}$	100	110		dB
INPUT CHARACTERISTICS					
Input Resistance			10		M Ω
			10		k Ω
Input Capacitance			3		pF
			11		pF
Input Common-Mode Voltage Range			-4.9 to +4.1		V
Common-Mode Rejection Ratio (CMRR)	$V_{CM} = -2\text{ V to }+2\text{ V}$	-92	-120		dB
OUTPUT CHARACTERISTICS					
Output Overdrive Recovery Time	$V_{IN} = \pm 5\text{ V}$, $G = +2$		81		ns
Output Voltage Swing	$R_L = 1\text{ k}\Omega$	4.85	4.96		V
			4.5	4.73	V
Positive	$R_L = 100\ \Omega$	-4.85	-4.97		V
			-4.5	-4.84	V
Negative	$R_L = 1\text{ k}\Omega$	-4.85	-4.97		V
			-4.5	-4.84	V
Output Current	SFDR = -45 dBc		80		mA
Short-Circuit Current	Sinking/sourcing		135		mA
Capacitive Load Drive	30% overshoot, $G = +2$		39		pF

Parameter	Test Conditions/Comments	Min	Typ	Max	Unit
POWER SUPPLY					
Operating Range			3 to 10		V
Quiescent Current per Amplifier		2.8	3.0	3.2	mA
	$\overline{\text{DISABLEx}} = -5\text{ V}$		0.13	0.25	mA
Power Supply Rejection Ratio (PSRR)					
Positive	$+V_S = 4\text{ V to }6\text{ V}, -V_S = -5\text{ V}$	-96	-125		dB
Negative	$+V_S = 5\text{ V}, -V_S = -4\text{ V to }-6\text{ V}$	-96	-121		dB
DISABLEx PIN					
$\overline{\text{DISABLEx}}$ Voltage	Enabled		$>+V_S - 0.5$		V
	Disabled		$<+V_S - 2$		V
Input Current					
Enabled	$\overline{\text{DISABLEx}} = +5\text{ V}$		-1.2		μA
Disabled	$\overline{\text{DISABLEx}} = -5\text{ V}$		-40		μA
Switching Speed					
Enabled			0.25		μs
Disabled			12		μs

+5 V SUPPLY

$T_A = 25^\circ\text{C}$, $G = +1$, $R_L = 1\text{ k}\Omega$ to midsupply, unless otherwise noted.

Table 2.

Parameter	Test Conditions/Comments	Min	Typ	Max	Unit
DYNAMIC PERFORMANCE					
-3 dB Bandwidth	$G = +1, V_{\text{OUT}} = 0.02\text{ V p-p}$		230		MHz
	$G = +1, V_{\text{OUT}} = 2\text{ V p-p}$		30		MHz
	$G = +2, V_{\text{OUT}} = 0.02\text{ V p-p}$		90		MHz
Bandwidth for 0.1 dB Flatness	$G = +2, V_{\text{OUT}} = 2\text{ V p-p}, R_L = 100\ \Omega$		7		MHz
Slew Rate	$G = +2, V_{\text{OUT}} = 3\text{ V step}$		100		$\text{V}/\mu\text{s}$
Settling Time to 0.1%	$G = +2, V_{\text{OUT}} = 2\text{ V step}$		45		ns
Settling Time to 0.01%	$G = +2, V_{\text{OUT}} = 2\text{ V step}$		95		ns
NOISE/HARMONIC PERFORMANCE					
Harmonic Distortion (SFDR)					
	$V_{\text{OUT}} = 2\text{ V p-p}$				
	$f_C = 100\text{ kHz}$		-115		dBc
	$f_C = 1\text{ MHz}$		-93		dBc
	$f_C = 2\text{ MHz}$		-80		dBc
	$f_C = 5\text{ MHz}$		-61		dBc
Input Voltage Noise					
	$f = 10\text{ Hz}$		2.4		$\text{nV}/\sqrt{\text{Hz}}$
	$f = 100\text{ kHz}$		1		$\text{nV}/\sqrt{\text{Hz}}$
Input Current Noise					
	$f = 10\text{ Hz}$		11		$\text{pA}/\sqrt{\text{Hz}}$
	$f = 100\text{ kHz}$		2.8		$\text{pA}/\sqrt{\text{Hz}}$
0.1 Hz to 10 Hz Noise	$G = +101, R_F = 1\text{ k}\Omega, R_G = 10\ \Omega$		99		nV p-p
DC PERFORMANCE					
Input Offset Voltage		-500	-30	+500	μV
Input Offset Voltage Drift			0.2		$\mu\text{V}/^\circ\text{C}$
Input Bias Current		-17	-11	-4	μA
Input Bias Current Drift			3		$\text{nA}/^\circ\text{C}$
Input Bias Offset Current		-0.6	-0.02	+0.6	μA
Open-Loop Gain	$V_{\text{OUT}} = 0.5\text{ V to }4.5\text{ V}$	97	110		dB

Parameter	Test Conditions/Comments	Min	Typ	Max	Unit
INPUT CHARACTERISTICS					
Input Resistance					
Common-Mode			10		MΩ
Differential			10		kΩ
Input Capacitance					
Common-Mode			3		pF
Differential			11		pF
Input Common-Mode Voltage Range			0.1 to 4.1		V
Common-Mode Rejection Ratio (CMRR)	$V_{CM} = 1\text{ V to }4\text{ V}$	-91	-118		dB
OUTPUT CHARACTERISTICS					
Output Overdrive Recovery Time	$V_{IN} = 0\text{ V to }5\text{ V}, G = +2$		96		ns
Output Voltage Swing					
Positive	$R_L = 1\text{ k}\Omega$	4.85	4.98		V
	$R_L = 100\ \Omega$	4.8	4.88		V
Negative	$R_L = 1\text{ k}\Omega$	0.15	0.014		V
	$R_L = 100\ \Omega$	0.2	0.08		V
Output Current	SFDR = -45 dBc		70		mA
Short-Circuit Current	Sinking/sourcing		125		mA
Capacitive Load Drive	30% overshoot, $G = +2$		39		pF
POWER SUPPLY					
Operating Range			3 to 10		V
Quiescent Current per Amplifier		2.6	2.8	2.9	mA
	$\overline{\text{DISABLEx}} = 0\text{ V}$		0.05	0.18	mA
Power Supply Rejection Ratio (PSRR)					
Positive	$+V_S = 4.5\text{ V to }5.5\text{ V}, -V_S = 0\text{ V}$	-96	-123		dB
Negative	$+V_S = 5\text{ V}, -V_S = -0.5\text{ V to }+0.5\text{ V}$	-96	-121		dB
DISABLEx PIN					
$\overline{\text{DISABLEx}}$ Voltage	Enabled		$>+V_S - 0.5$		V
	Disabled		$<+V_S - 2$		V
Input Current					
Enabled	$\overline{\text{DISABLEx}} = 5\text{ V}$		-1.2		μA
Disabled	$\overline{\text{DISABLEx}} = 0\text{ V}$		-20		μA
Switching Speed					
Enabled			0.25		μs
Disabled			12		μs

+3 V SUPPLY

$T_A = 25^\circ\text{C}$, $G = +1$, $R_L = 1\text{ k}\Omega$ to midsupply, unless otherwise noted.

Table 3.

Parameter	Test Conditions/Comments	Min	Typ	Max	Unit
DYNAMIC PERFORMANCE					
-3 dB Bandwidth	$G = +1, V_{OUT} = 0.02\text{ V p-p}$		230		MHz
	$G = -1, V_{OUT} = 1\text{ V p-p}$		45		MHz
Bandwidth for 0.1 dB Flatness	$G = +2, V_{OUT} = 0.02\text{ V p-p}$		90		MHz
	$G = +2, V_{OUT} = 2\text{ V p-p}, R_L = 100\ \Omega$		7		MHz
Slew Rate	$G = +2, V_{OUT} = 1\text{ V step}$		85		V/ μs
Settling Time to 0.1%	$G = +2, V_{OUT} = 2\text{ V step}$		45		ns
Settling Time to 0.01%	$G = +2, V_{OUT} = 2\text{ V step}$		96		ns
NOISE/HARMONIC PERFORMANCE					
Harmonic Distortion (SFDR)	$f_C = 100\text{ kHz}, V_{OUT} = 2\text{ V p-p}, G = +2$		-105		dBc
	$f_C = 1\text{ MHz}, V_{OUT} = 1\text{ V p-p}, G = -1$		-84		dBc
	$f_C = 2\text{ MHz}, V_{OUT} = 1\text{ V p-p}, G = -1$		-77		dBc
	$f_C = 5\text{ MHz}, V_{OUT} = 1\text{ V p-p}, G = -1$		-60		dBc
Input Voltage Noise	$f = 10\text{ Hz}$		2.3		nV/ $\sqrt{\text{Hz}}$
	$f = 100\text{ kHz}$		1		nV/ $\sqrt{\text{Hz}}$
Input Current Noise	$f = 10\text{ Hz}$		11		pA/ $\sqrt{\text{Hz}}$
	$f = 100\text{ kHz}$		2.8		pA/ $\sqrt{\text{Hz}}$
0.1 Hz to 10 Hz Noise	$G = +101, R_F = 1\text{ k}\Omega, R_G = 10\ \Omega$		99		nV p-p
DC PERFORMANCE					
Input Offset Voltage		-500	-30	+500	μV
Input Offset Voltage Drift			0.2		$\mu\text{V}/^\circ\text{C}$
Input Bias Current		-17	-11	-4	μA
Input Bias Current Drift			3		nA/ $^\circ\text{C}$
Input Bias Offset Current		-0.6	-0.02	+0.6	μA
Open-Loop Gain	$V_{OUT} = 0.5\text{ V to }2.5\text{ V}$	95	108		dB
INPUT CHARACTERISTICS					
Input Resistance			10		M Ω
			10		k Ω
Input Capacitance			3		pF
			11		pF
Input Common-Mode Voltage Range			0.1 to 2.1		V
Common-Mode Rejection Ratio (CMRR)	$V_{CM} = 1.1\text{ V to }1.9\text{ V}$	-90	-124		dB
OUTPUT CHARACTERISTICS					
Output Overdrive Recovery Time	$V_{IN} = 0\text{ V to }3\text{ V}, G = +2$		83		ns
Output Voltage Swing	$R_L = 1\text{ k}\Omega$	Positive	2.85	2.97	V
		Negative	2.8	2.92	V
Output Current	$R_L = 100\ \Omega$	Positive	0.15	0.01	V
		Negative	0.2	0.05	V
Short-Circuit Current	Sinking/sourcing		60		mA
Capacitive Load Drive	30% overshoot, $G = +2$		120		mA
			39		pF

Parameter	Test Conditions/Comments	Min	Typ	Max	Unit
POWER SUPPLY					
Operating Range			3 to 10		V
Quiescent Current per Amplifier		2.5	2.7	2.9	mA
	$\overline{\text{DISABLEx}} = 0\text{V}$		0.035	0.15	mA
Power Supply Rejection Ratio (PSRR)					
Positive	$+V_s = 2.7\text{V to } 3.7\text{V}, -V_s = 0\text{V}$	-96	-121		dB
Negative	$+V_s = 3\text{V}, -V_s = -0.3\text{V to } +0.7\text{V}$	-96	-120		dB
DISABLEx PIN					
$\overline{\text{DISABLEx}}$ Voltage	Enabled		$>+V_s - 0.5$		V
	Disabled		$<-V_s + 2$		V
Input Current					
Enabled	$\overline{\text{DISABLEx}} = 3\text{V}$		-1.2		μA
Disabled	$\overline{\text{DISABLEx}} = 0\text{V}$		-15		μA
Switching Speed					
Enabled			0.25		μs
Disabled			12		μs

ABSOLUTE MAXIMUM RATINGS

Table 4.

Parameter	Rating
Supply Voltage	12.6 V
Common-Mode Input Voltage	$\pm V_S \pm 0.5 \text{ V}$
Differential Input Voltage	$\pm 1.8 \text{ V}$
Storage Temperature Range	-65°C to +125°C
Operating Temperature Range	-40°C to +125°C
Junction Temperature	150°C

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

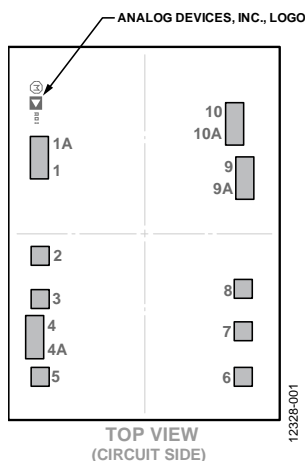


Figure 1. Pad Configuration

Table 5. Pad Function Descriptions

Pad No.	X-Axis	Y-Axis	Mnemonic	Description
1	-402	+279	OUT1	Output 1
1A	-402	+354	OUT1	Output 1, Double Bond Pad
2	-400	-41	-IN1	Inverting Input 1
3	-400	-197	+IN1	Noninverting Input 1
4	-420	-303	-V _s	Negative Supply
4A	-420	-378	-V _s	Negative Supply, Double Bond Pad
5	-395	-485	$\overline{\text{DISABLE1}}$	Disable Control 1
6	+395	-485	$\overline{\text{DISABLE2}}$	Disable Control 2
7	+402	-317	+IN2	Noninverting Input 2
8	+402	-161	-IN2	Inverting Input 2
9	+402	+275	OUT2	Output 2
9A	+402	+203	OUT2	Output 2, Double Bond Pad
10	+364	+477	+V _s	Positive Supply
10A	+364	+402	+V _s	Positive Supply, Double Bond Pad

OUTLINE DIMENSIONS

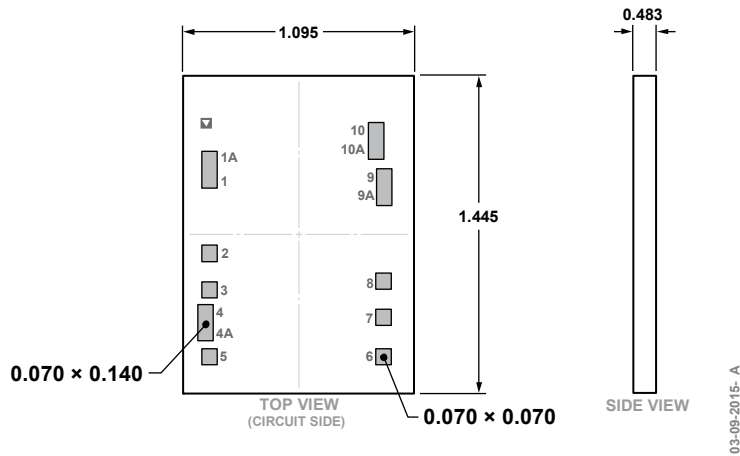


Figure 2. 10-Pad Bare Die [CHIP]
(C-10-6)
Dimensions shown in millimeters

DIE SPECIFICATIONS AND ASSEMBLY RECOMMENDATIONS

Table 6. Die Specifications

Parameter	Value	Unit
Scribe Line Width	75	μm
Die Size (Maximum Size)	1095 × 1445	μm
Thickness	483	μm
Bond Pads (Minimum Size)	70 × 70	μm
Bond Pad Composition	1% AlCu	%
Backside	Si	Not applicable
Passivation	Doped oxide/SiN	Not applicable
ESD	HBM 2000	V

Table 7. Assembly Recommendations

Assembly Component	Recommendation
Die Attach	Ablestik 84-1LMIS R4
Bonding Method	1 mil gold

ORDERING GUIDE

Model	Temperature Range	Package Description	Package Option
ADA4897-2-KGD	-40°C to +125°C	10-Pad Bare Die [CHIP]	C-10-6